



OK to enter
ON 3/16/07

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 2815
Examiner: Mr. Joseph H. Nguyen

In re PATENT APPLICATION of:

Applicant : Takashi NOGUCHI)
Serial No. : 10/822,691)
Filed : April 13, 2004)
For : HEAT RADIATION STRUCTURE)
OF SEMICONDUCTOR DEVICE,)
AND MANUFACTURING)
METHOD THEREOF)
Atty Ref. : OKI 419)

AMENDMENT
AFTER
FINAL REJECTION

February 28, 2007

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of September 25, 2006, the period for reply to which is being extended to expire on March 25, 2007 by a Petition filed concurrently herewith.

A fee of \$ 1020 is also being submitted concurrently. Should this remittance be accidentally missing, though, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.